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IPB180P04P4L02ATMA1

Infineon Technologies

MOSFET P-Ch -40V -180A D2PAK-6 OptiMOS-P2

Any questions,please feel free to contact us.
info@kaimte.com

OptiMOS®-P2 Power-Transistor

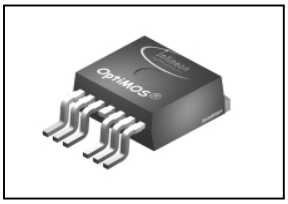
Product Summary

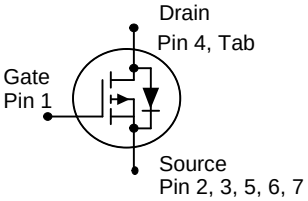
V_{DS}	-40	V
$R_{DS(on),max}$	2.4	mΩ
I_D	-180	A

Features

- P-channel - Logic Level - Enhancement mode
- AEC qualified
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- Green Product (RoHS compliant)
- 100% Avalanche tested
- Intended for reverse battery protection

PG-TO263-7-3





Type	Package	Marking
IPB180P04P4L-02	PG-TO263-7-3	4QP04L02

Maximum ratings, at T_j=25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I_D	T_C=25°C, V_{GS}=-10V[1)]	-180	A
		T_C=100°C, V_{GS}=-10V[2)]	-140	
Pulsed drain current[2)]	$I_{D,pulse}$	T_C=25°C	-720	
Avalanche energy, single pulse	E_{AS}	I_D= -90A	84	mJ
Avalanche current, single pulse	I_{AS}	-	-180	A
Gate source voltage	V_{GS}	-	±16[3)]	V
Power dissipation	P_{tot}	T_C=25°C	150	W
Operating and storage temperature	T_j, T_{stg}	-	-55 ... +175	°C
IEC climatic category; DIN IEC 68-1	-	-	55/175/56	

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Thermal characteristics[2]						
Thermal resistance, junction - case	R_{thJC}	-	-	-	1	K/W
SMD version, device on PCB	R_{thJA}	minimal footprint	-	-	62	
		6 cm^2 cooling area[4]	-	-	40	
Electrical characteristics, at T_j=25 °C, unless otherwise specified						
Static characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	V_{GS}=0V, I_D= -1mA	-40	-	-	V
Gate threshold voltage	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D=-410µA	-1.2	-1.7	-2.2	
Zero gate voltage drain current	I_{DSS}	V_{DS}=-32V, V_{GS}=0V, T_j=25°C	-	-0.1	-1	µA
		V_{DS}=-32V, V_{GS}=0V, T_j=125°C[2]	-	-20	-200	
Gate-source leakage current	I_{GSS}	V_{GS}=-16V, V_{DS}=0V	-	-	-100	nA
Drain-source on-state resistance	$R_{DS(on)}$	V_{GS}=-4.5V, I_D=-100A	-	2.6	3.9	mΩ
		V_{GS}=-10V, I_D=-100A	-	1.8	2.4	

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Dynamic characteristics[2]						
Input capacitance	C_{iss}	V_{GS}=0V, V_{DS}=-25V, f=1MHz	-	14400	18700	pF
Output capacitance	C_{oss}		-	4570	5900	
Reverse transfer capacitance	C_{rss}		-	180	360	
Turn-on delay time	$t_{d(on)}$	V_{DD}=-20V, V_{GS}=-10V, I_D=-180A, R_G=3.5Ω	-	32	-	ns
Rise time	t_r		-	28	-	
Turn-off delay time	$t_{d(off)}$		-	146	-	
Fall time	t_f		-	119	-	
Gate Charge Characteristics[2]						
Gate to source charge	Q_{gs}	V_{DD}=-32 V, I_D=-180 A, V_{GS}=0 to -10 V	-	50	65	nC
Gate to drain charge	Q_{gd}		-	38	76	
Gate charge total	Q_g		-	220	286	
Gate plateau voltage	$V_{plateau}$		-	-3.5	-	V
Reverse Diode						
Diode continous forward current[2]	I_S	T_C=25°C	-	-	-180	A
Diode pulse current[2]	$I_{S,pulse}$		-	-	-720	
Diode forward voltage	V_{SD}	V_{GS}=0V, I_F=-100A, T_j=25°C	-	-1.0	-1.3	V
Reverse recovery time[2]	t_{rr}	V_R=-20V, I_F=-50A, di_F/dt=-100A/µs	-	71	-	ns
Reverse recovery charge[2]	Q_{rr}		-	101	-	nC

[1] Current is limited by bondwire; with an R_{thJC} = 1K/W the chip is able to carry 200A at 25°C.

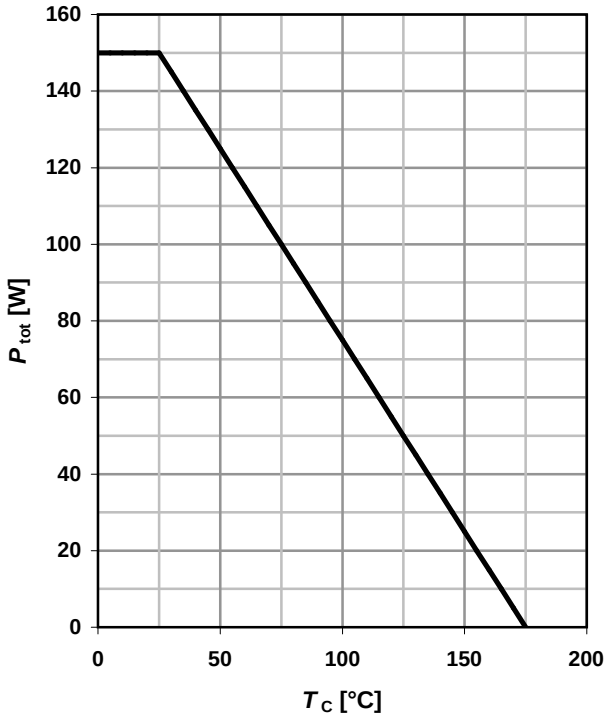
[2] Specified by design. Not subject to production test.

[3] V_{GS}=+5V/-16V according AEC; V_{GS}=+16V for max 168h at T_J=175°C

[4] Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm^2 (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

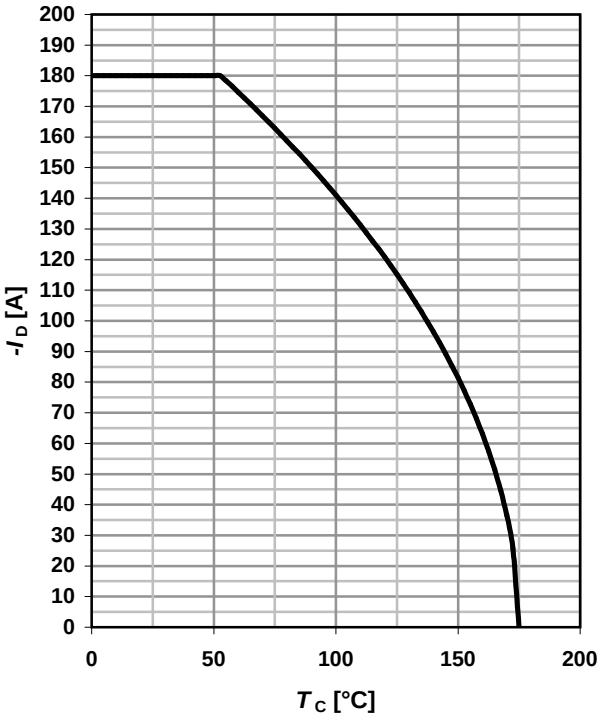
1 Power dissipation

$P_{tot} = f(T_C)$; $V_{GS} \leq -6V$



2 Drain current

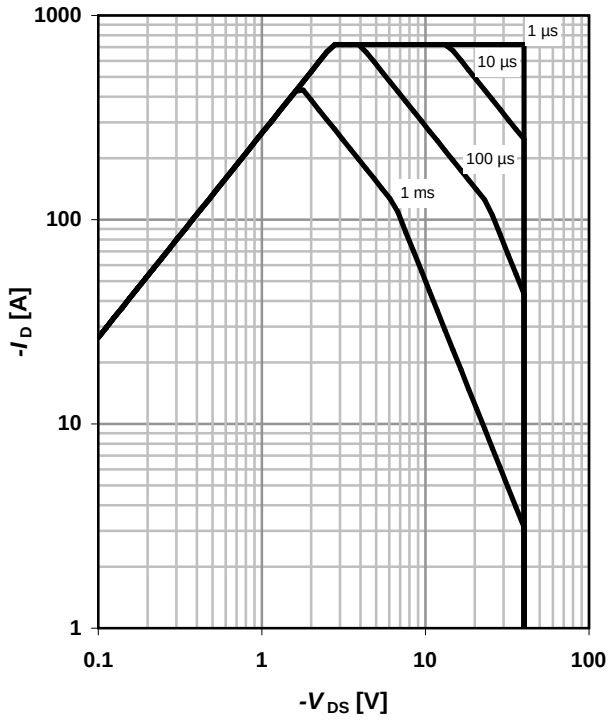
$I_D = f(T_C)$; $V_{GS} \leq -6V$



3 Safe operating area

$I_D = f(V_{DS})$; $T_C = 25$ °C; $D = 0$

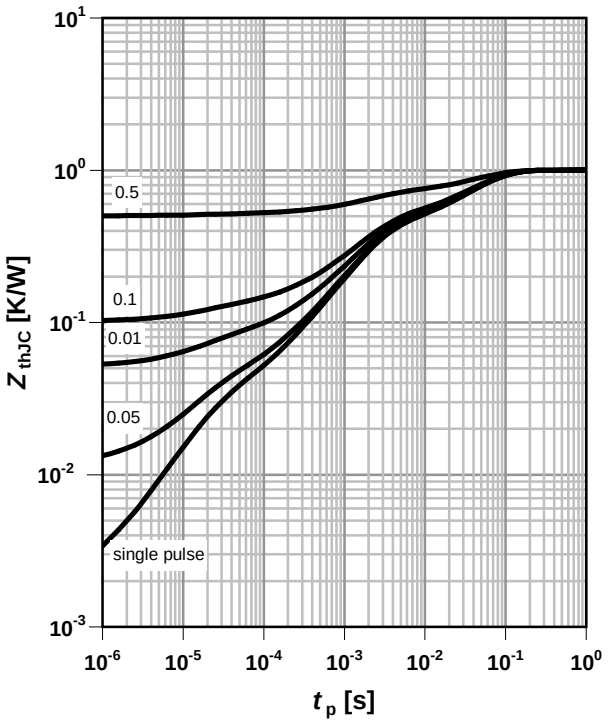
parameter: t_p



4 Max. transient thermal impedance

$Z_{thJC} = f(t_p)$

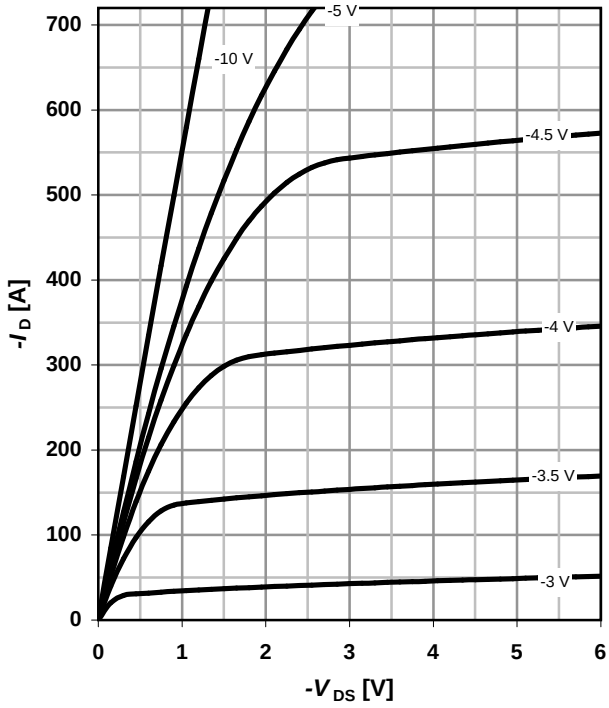
parameter: $D = t_p/T$



5 Typ. output characteristics

$I_D = f(V_{DS})$; $T_j = 25°C$

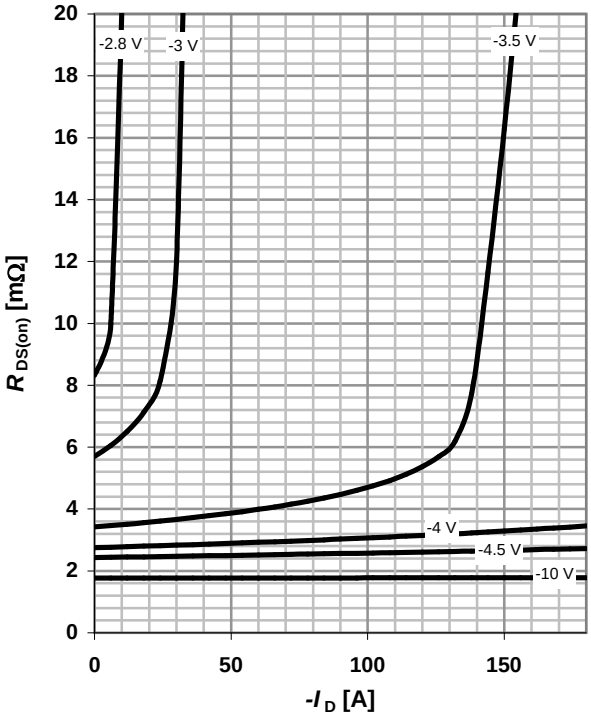
parameter: V_{GS}



6 Typ. drain-source on-state resistance

$R_{DS(on)} = f(I_D)$; $T_j = 25°C$

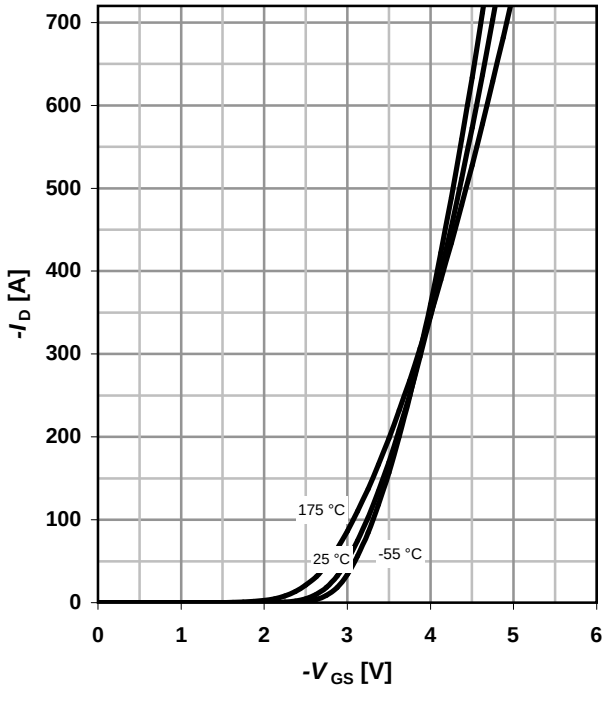
parameter: V_{GS}



7 Typ. transfer characteristics

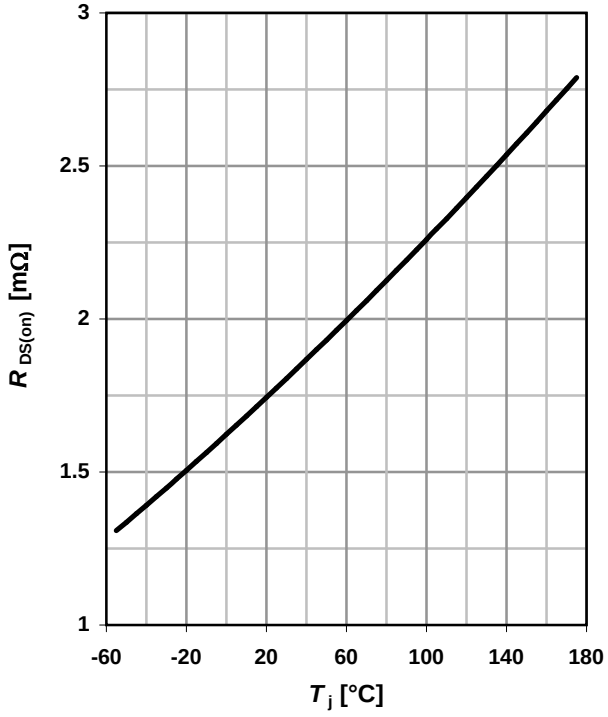
$I_D = f(V_{GS})$; $V_{DS} = -6V$

parameter: T_j



8 Typ. drain-source on-state resistance

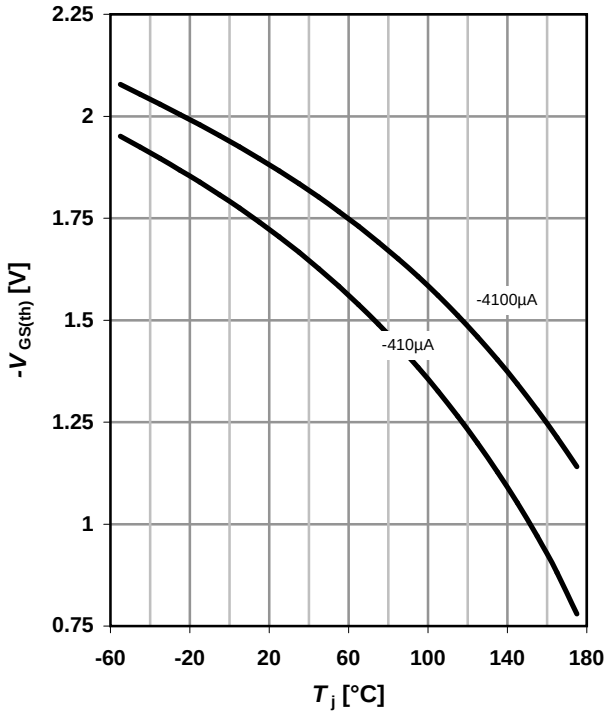
$R_{DS(on)} = f(T_j)$; $I_D = -100A$; $V_{GS} = -10V$



9 Typ. gate threshold voltage

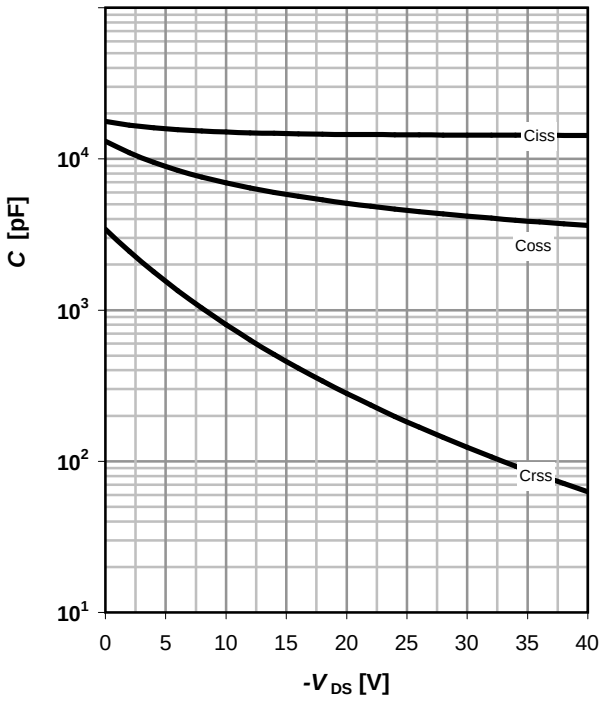
$V_{GS(th)} = f(T_j)$; $V_{GS} = V_{DS}$

parameter: I_D



10 Typ. capacitances

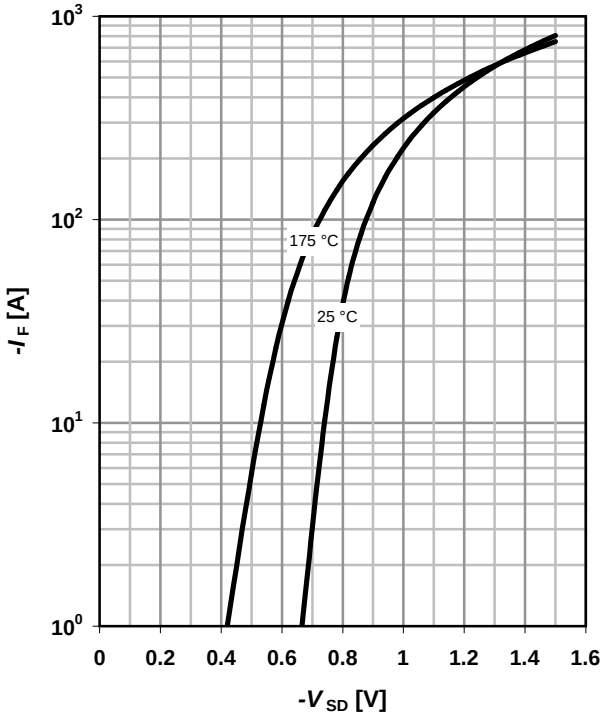
$C = f(V_{DS})$; $V_{GS} = 0$ V; $f = 1$ MHz



11 Typical forward diode characteristicis

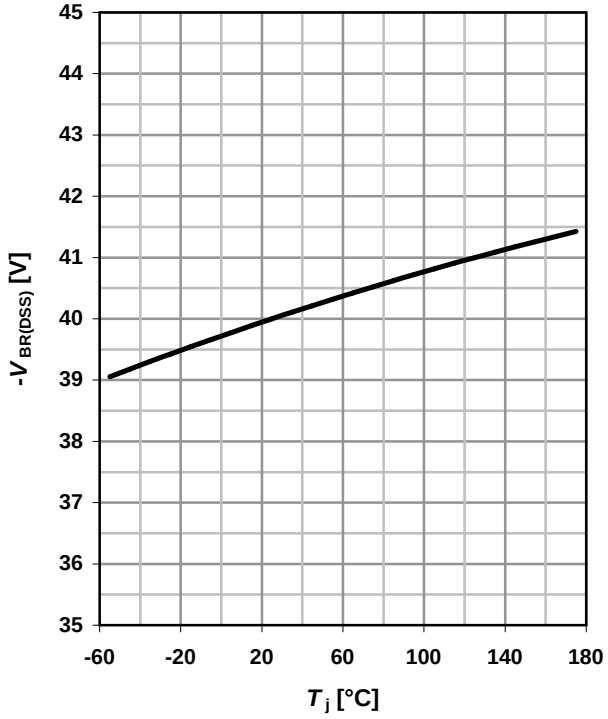
$I_F = f(V_{SD})$

parameter: T_j



12 Drain-source breakdown voltage

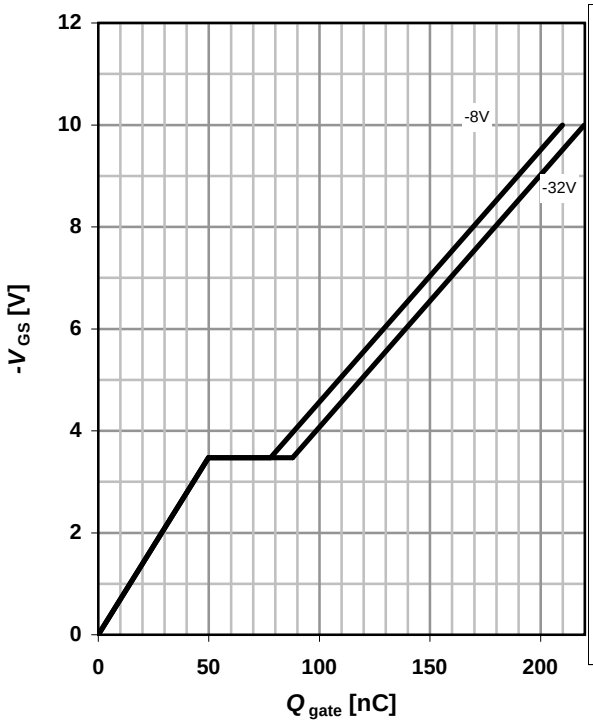
$V_{BR(DSS)} = f(T_j)$; $I_D = -1$mA



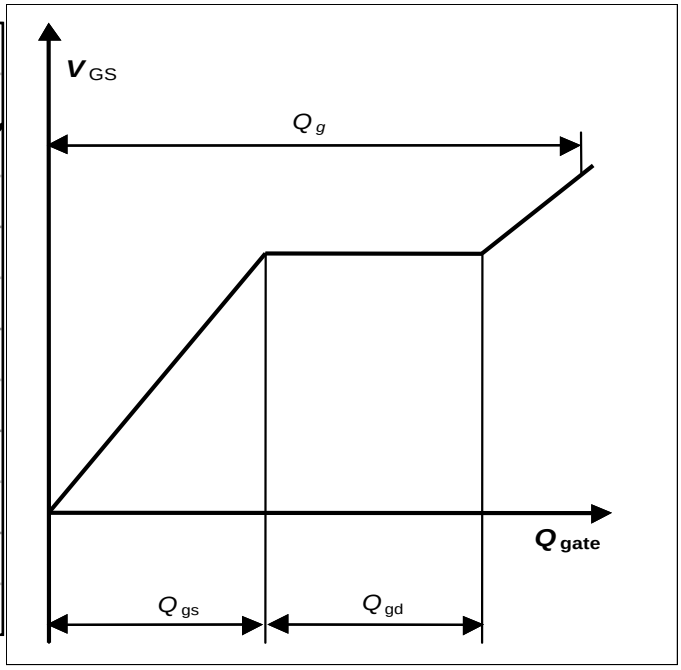
13 Typ. gate charge

$V_{GS} = f(Q_{gate})$; I_D = -180A pulsed

parameter: V_{DD}



14 Gate charge waveforms



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If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

Revision History

Version	Date	Changes
1.1	02.09.2009	$R_{DS(on)}$@4.5V: Id changed to 135A
1.1	02.09.2009	$V_{GS(th)}$: I_D changed to 410uA
1.2	07.10.2009	$R_{DS(on)}$@4.5V: I_D changed to 80A
1.2	07.10.2009	$R_{DS(on)}$@10V: I_D changed to 80A
1.2	07.10.2009	V_{SD}: I_D changed to 80A
1.3	27.04.2011	Final Data Sheet

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